

N-Channel 100 V (D-S) 175 °C MOSFET

PRODUC	ODUCT SUMMARY			
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
100	0.005 at V _{GS} = 10 V	110 ^a		

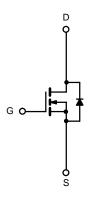
FEATURES

- TrenchFET® Power MOSFET
- New Package with Low Thermal Resistance
- 100 % R_g Tested









N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	100	V	
Gate-Source Voltage	V_{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1	110 ^a	А
	T _C = 125 °C	l _D	87 ^a	
Pulsed Drain Current	I _{DM}	440		
Avalanche Current		I _{AR}	75	
Repetitive Avalanche Energy ^b L = 0.1 mH		E _{AR}	280	mJ
Maximum Power Dissipation ^b	T _C = 25 °C	375 ^c		W
	T _A = 25 °C	P _D	3.75	VV
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV	

Notes:

- a. Package limited.

- a. Fackage liffilled.
 b. Duty cycle ≤ 1 %.
 c. See SOA curve for voltage derating.
 d. When mounted on 1" square PCB (FR-4 material).

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V			1	
	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μA
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
		V _{GS} = 10 V, I _D = 30 A		0.004	0.005	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C			0.017	Ω
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.025	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		6700		pF
Output Capacitance	C _{oss}			750		
Reverse Transfer Capacitance	C _{rss}			280		
Total Gate Charge ^c	Qg			110	160	nC
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		24		
Gate-Drain Charge ^c	Q_{gd}			24		
Gate Resistance	R _g		1.0		6.2	Ω
Turn-On Delay Time ^c	t _{d(on)}			20	30	
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 0.6 Ω I_D \cong 85 A, V_{GEN} = 10 V, R_g = 2.5 Ω		125	200	ns
Turn-Off Delay Time ^c	t _{d(off)}			55	85	
Fall Time ^c	t _f			130	195	
Source-Drain Diode Ratings and Cha	aracteristics 7	「 _C = 25 °C ^b		•		
Continuous Current	Is				110	^
Pulsed Current	I _{SM}				240	A
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V
Reverse Recovery Time	t _{rr}			70	140	ns
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/μs		5.5	10	Α
Reverse Recovery Charge	Q _{rr}			0.19	0.35	μC

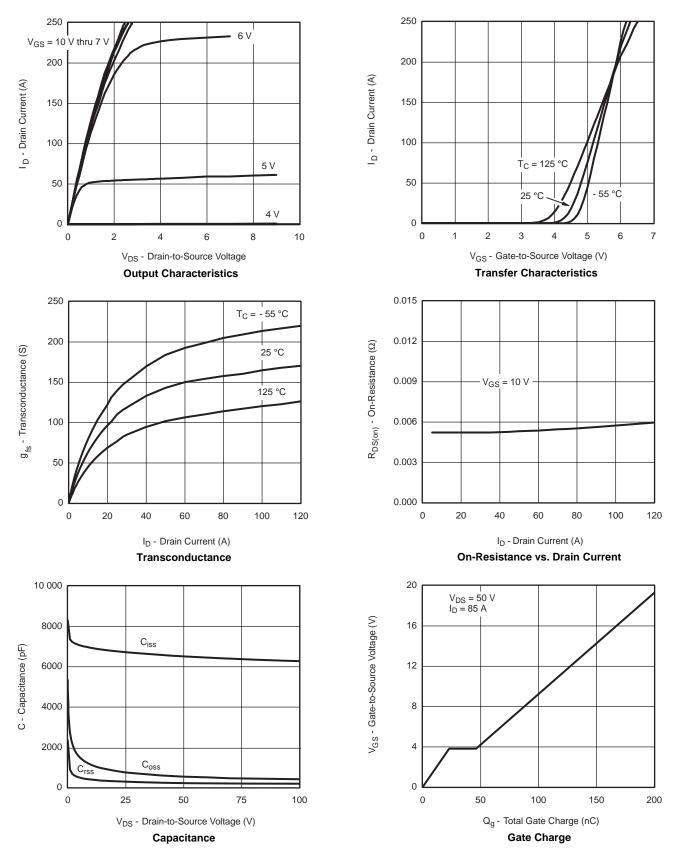
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

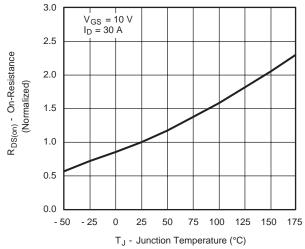


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

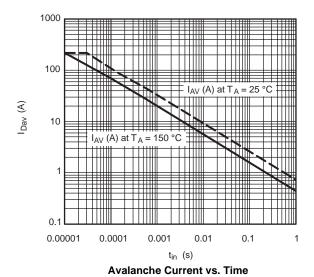




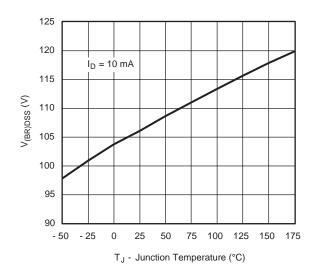
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On-Resistance vs. Junction Temperature



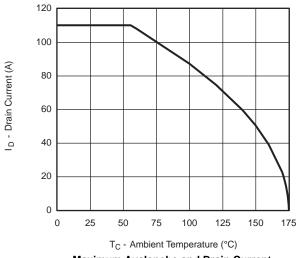
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature

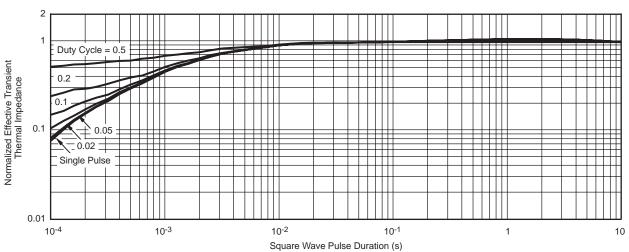


THERMAL RATINGS



 $(V_{\text{DS}} - \text{Drain-to-Source Voltage} (V) \\ V_{\text{GS}} > \text{minimum } V_{\text{GS}} \text{ at which } R_{\text{DS}(\text{on})} \text{ is specified} \\ \text{Safe Operating Area} \\ 1000 \, \mus \\ 100 \, \mu$

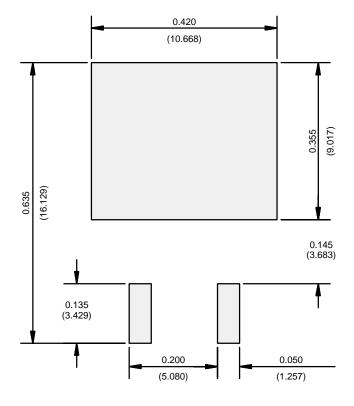
Maximum Avalanche and Drain Current vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case



RECOMMENDED MINIMUM PADS FOR D2PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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